

DOCKET NO: 247830US20CONT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :  
QIN-YI TONG ET AL. : ATTN: APPLICATION DIVISION  
SERIAL NO: NEW U.S. CONT APPLN. :  
(Based on 09/505,283)  
FILED: HERewith :  
FOR: METHOD FOR LOW :  
TEMPERATURE BONDING AND  
BONDED STRUCTURE

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 6 of this paper.

**Remarks/Arguments** begin on page 9 of this paper.